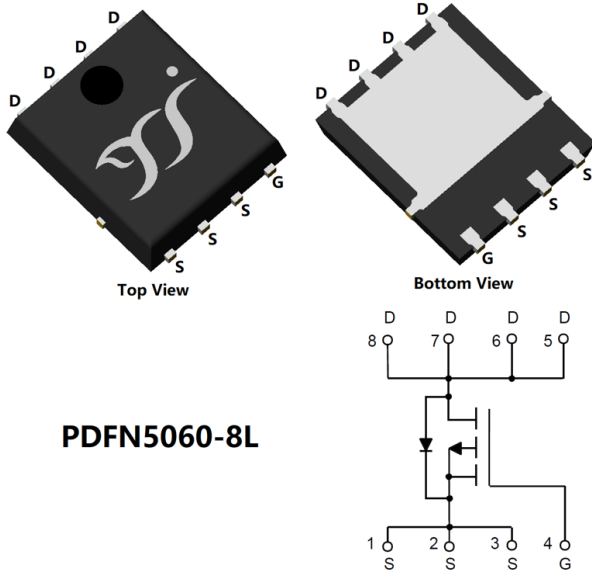


P-Channel Enhancement Mode Field Effect Transistor



PDFN5060-8L

Product Summary

- V_{DS} -60 V
- I_D -80 A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) <8.5 m Ω
- 100% EAS Tested
- 100% ∇V_{DS} Tested

General Description

- Split gate trench MOSFET technology
- Low $R_{DS(on)}$ & FOM
- Excellent stability and uniformity
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power management
- Portable equipment

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | | Symbol | Limit | Unit |
|--|-------------------|----------------|----------|------------|
| Drain-source Voltage | | V_{DS} | -60 | V |
| Gate-source Voltage | | V_{GS} | ± 18 | V |
| Drain Current | $T_A=25^\circ C$ | I_D | -12 | A |
| | $T_A=100^\circ C$ | | -7.5 | |
| | $T_C=25^\circ C$ | | -80 | |
| | $T_C=100^\circ C$ | | -50 | |
| Pulsed Drain Current ^A | | I_{DM} | -320 | A |
| Avalanche energy ^B | | EAS | 400 | mJ |
| Total Power Dissipation ^C | $T_A=25^\circ C$ | P_D | 2.5 | W |
| | $T_A=100^\circ C$ | | 1 | |
| | $T_C=25^\circ C$ | | 120 | |
| | $T_C=100^\circ C$ | | 48 | |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55~+150 | $^\circ C$ |

■ Thermal resistance

| Parameter | | Symbol | Typ | Max | Units |
|---|--------------|-----------------|-----|------|--------------|
| Thermal Resistance Junction-to-Ambient ^D | Steady-State | $R_{\theta JA}$ | 40 | 50 | $^\circ C/W$ |
| Thermal Resistance Junction-to-Case | Steady-State | $R_{\theta JC}$ | 0.8 | 1.04 | |

■ Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|------------|----------------------|-------------------------|----------------------------|---------------|
| YJG80GP06B | F1 | YJG80GP06B | 5000 | 10000 | 100000 | 13" reel |



YJG80GP06B

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---------------------------------------|---------------------|--|-----|------|------|-------|
| Static Parameter | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} = 0V, I _D =-250μA | -60 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-60V, V _{GS} =0V | - | - | -1 | μA |
| | | V _{DS} =-60V, V _{GS} =0V, T _J =150°C | - | - | -100 | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} = ±18V, V _{DS} =0V | - | - | ±100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D =-250μA | -2 | -2.7 | -4 | V |
| Static Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =-10V, I _D =-20A | - | 6.5 | 8.5 | mΩ |
| Diode Forward Voltage | V _{SD} | I _S =-20A, V _{GS} =0V | - | -0.9 | -1.3 | V |
| Gate resistance | R _G | f=1MHz, Open drain | - | 10 | - | Ω |
| Maximum Body-Diode Continuous Current | I _S | | - | - | -80 | A |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =-30V, V _{GS} =0V, f=1MHz | - | 5450 | - | pF |
| Output Capacitance | C _{oss} | | - | 900 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 65 | - | |
| Switching Parameters | | | | | | |
| Total Gate Charge | Q _g | V _{GS} =-10V, V _{DS} =-30V, I _D =-20A | - | 82 | - | nC |
| Gate-Source Charge | Q _{gs} | | - | 25 | - | |
| Gate-Drain Charge | Q _{gd} | | - | 17 | - | |
| Reverse Recovery Charge | Q _{rr} | I _F =-20A, di/dt=500A/us | - | 45 | - | nC |
| Reverse Recovery Time | t _{rr} | | - | 150 | - | ns |
| Turn-on Delay Time | t _{D(on)} | V _{GS} =-10V, V _{DD} =-30V, R _{GEN} =1.6Ω, I _D =-20A | - | 15 | - | ns |
| Turn-on Rise Time | t _r | | - | 50 | - | |
| Turn-off Delay Time | t _{D(off)} | | - | 135 | - | |
| Turn-off fall Time | t _f | | - | 160 | - | |

A. Repetitive rating; pulse width limited by max. junction temperature.

B. T_J=25°C, V_{DD}=-60V, V_G=-10V, R_G=25Ω, L=2mH, I_{AS}=-20A.

C. P_d is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.

D. The value of RθJA is measured with the device mounted on the minimum recommend pad size, in the still air environment with TA =25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.



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Typical Electrical and Thermal Characteristics Diagrams

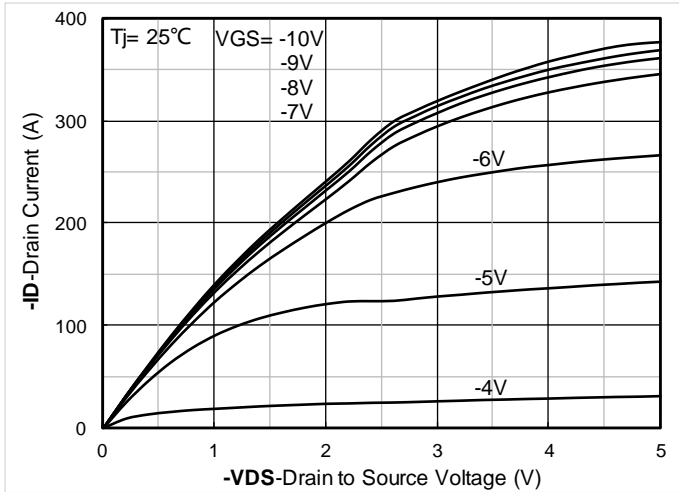


Figure 1. Output Characteristics

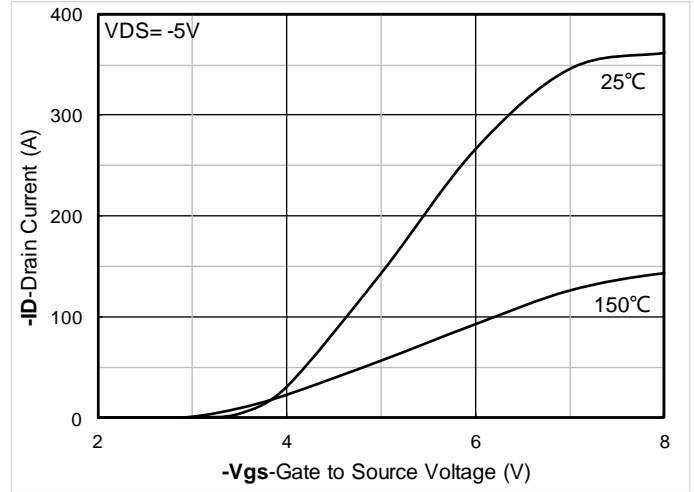


Figure 2. Transfer Characteristics

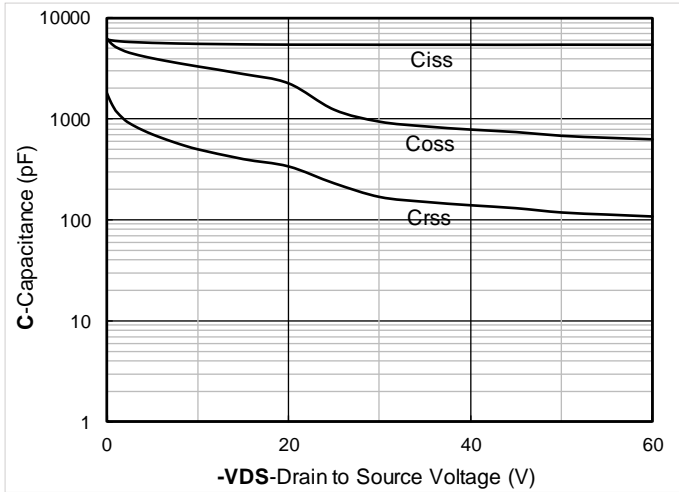


Figure 3. Capacitance Characteristics

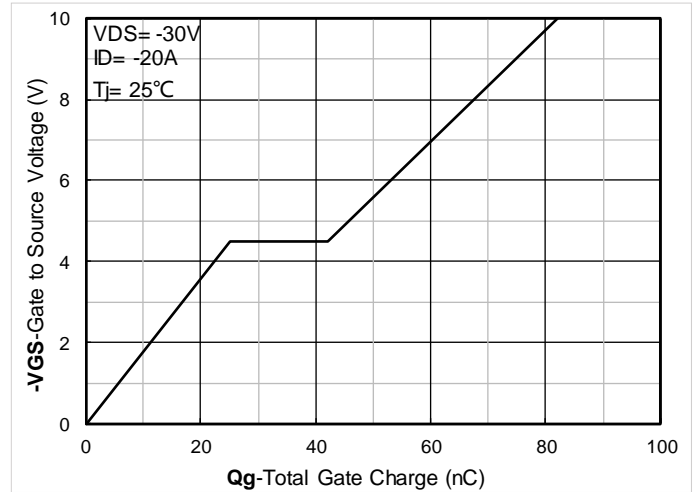


Figure 4. Gate Charge

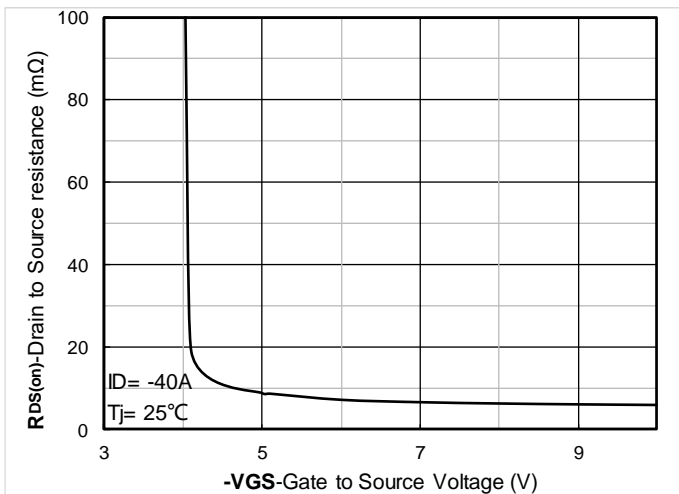


Figure 5. On-Resistance vs Gate to Source Voltage

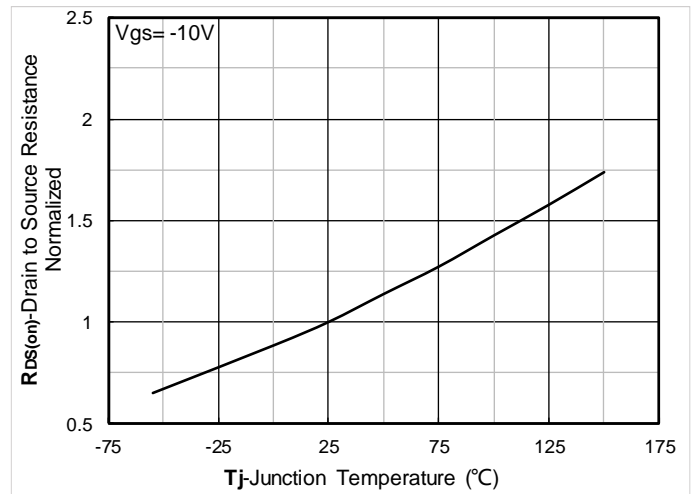


Figure 6. Normalized On-Resistance



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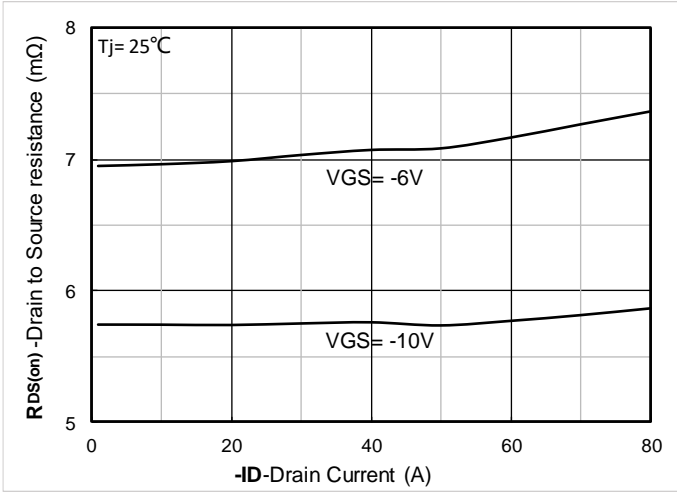


Figure 7. $R_{DS(on)}$ VS Drain Current

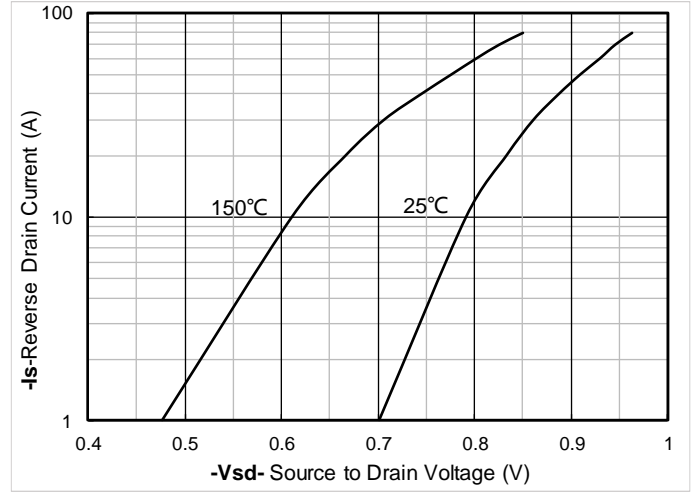


Figure 8. Forward characteristics of reverse diode

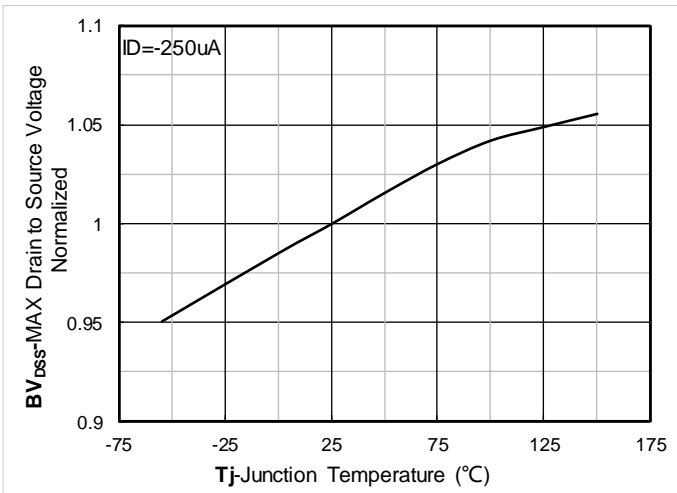


Figure 9. Normalized breakdown voltage

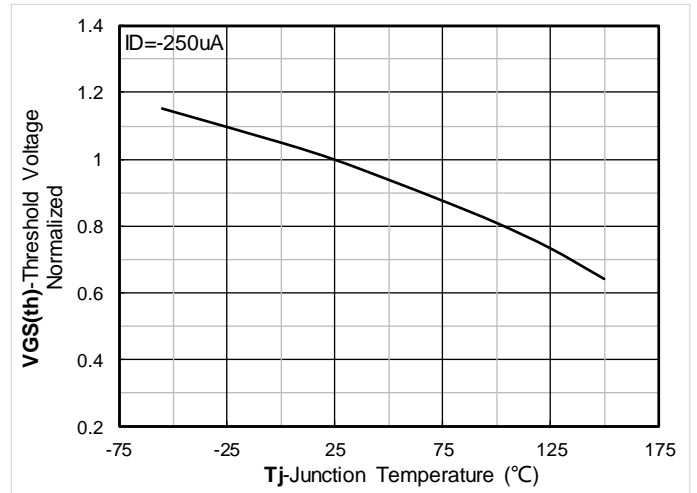


Figure 10. Normalized Threshold voltage

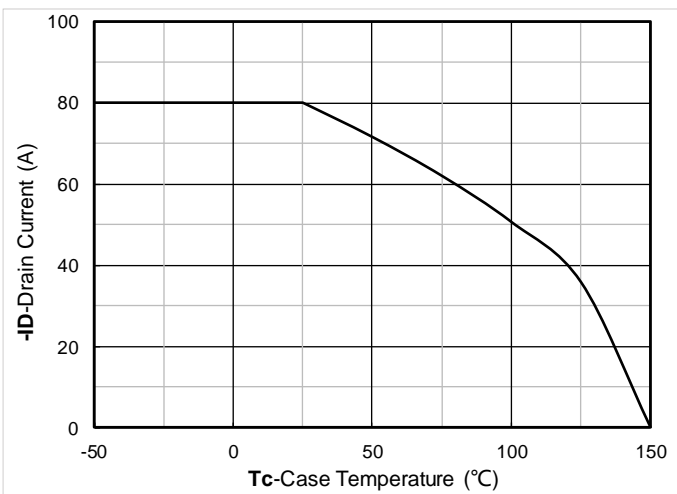


Figure 11. Current dissipation

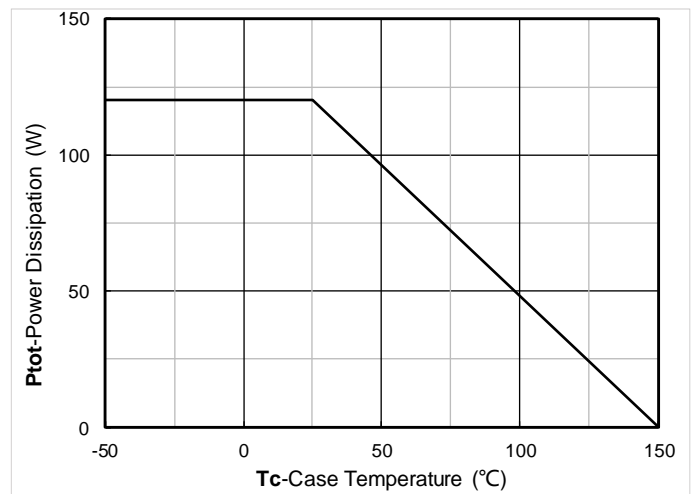


Figure 12. Power dissipation



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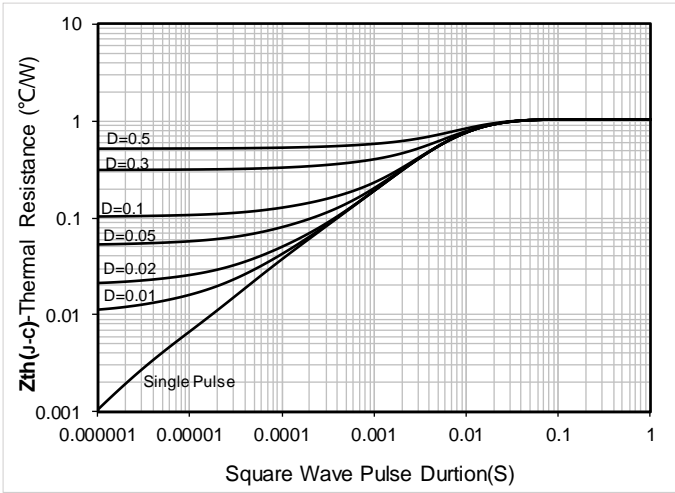


Figure 13. Maximum Transient Thermal Impedance

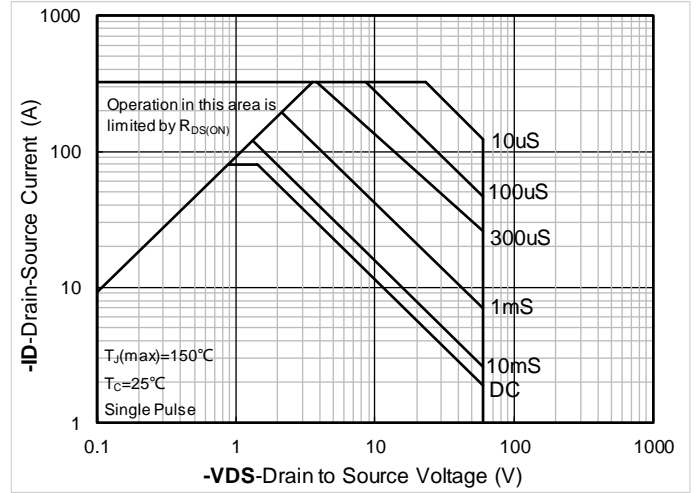
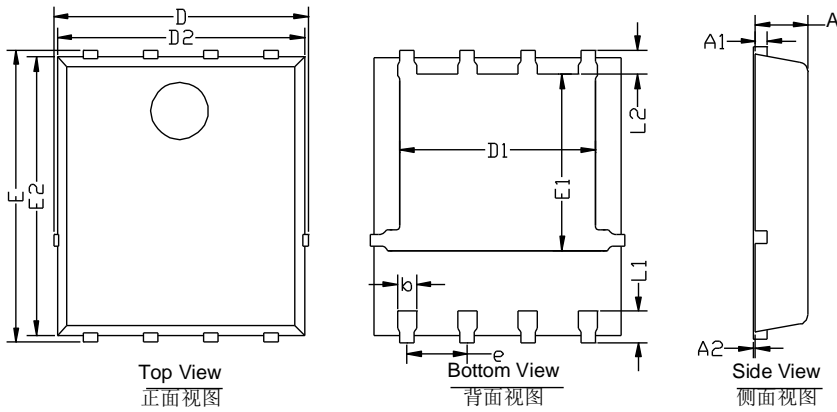


Figure 14. Safe Operation Area

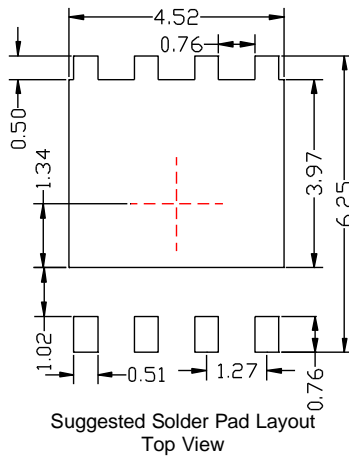


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■ PDFN5060-8L Package information



| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN | NOM | MAX |
| D | 5.15 | 5.35 | 5.55 |
| E | 5.95 | 6.15 | 6.35 |
| A | 1.00 | 1.10 | 1.20 |
| A1 | 0.254 BSC | | |
| A2 | | | 0.10 |
| D1 | 3.92 | 4.12 | 4.32 |
| E1 | 3.52 | 3.72 | 3.92 |
| D2 | 5.00 | 5.20 | 5.40 |
| E2 | 5.66 | 5.86 | 6.06 |
| L1 | 0.56 | 0.66 | 0.76 |
| L2 | 0.50 BSC | | |
| b | 0.31 | 0.41 | 0.51 |
| e | 1.27 BSC | | |



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.10\text{mm}$.
 3. The pad layout is for reference purposes only.



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